



EMV[®] Specification Bulletin No. 296

May 2023

EMV[®] 3-D Secure SDK Specification version 2.3.1.1

This Specification Bulletin No. 296 provides updates, clarifications and errata incorporated since the August 2022 release of version 2.3.1.0.

Applicability

This Specification Bulletin applies to:

- EMV[®] 3-D Secure SDK Specification, Version 2.3.1.1

Updates are provided in the order in which they appear in the specification. Deleted text is identified using strikethrough, and red font is used to identify changed text. Unedited text is provided only for context.

Related Documents

EMV[®] 3-D Secure SDK Specification, Version 2.3.1.0

Effective Date

- May 2023
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Chapter 7 User Interface

7.1 HTML UI

Requirement 75 was deleted from the EMV 3-D Secure SDK Specification and incorporated into the EMV 3-D Secure Protocol and Core Functions Specification (hereinafter referred to as the Core Specification).

[Req 75]

~~When the Cardholder submits their response, if the 3DS SDK receives a blank response, then it shall assume that the HTML is not valid. In this event, the 3DS SDK shall return to the ACS an Error message (as defined in Section A.9 of the Core Specification) with Error Component = C and Error Code = 203.~~

7.2 Native UI

Requirement 71 was deleted from the EMV 3-D Secure SDK Specification and incorporated into the Core Specification.

[Req 71]

~~If the Cardholder does not enter any data in the UI, the Challenge No Entry field shall be sent in the CReq message with the value = Y.~~



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